# H-613

## 【Introduction】

H–613 is twin–pack normal temperature curing adhesive which is made by modified bisphenol aepoxy resin and aromatic amine glycidyl ether epoxy resin coolymerization after, adding modified amine curing agent, with excellent bondability, excellent performance under low–high temperature and humidity, cured under room temperature, lower creep and good insulation.

H–613 is suitable for most strain gages, compensation resistors and terminals bonding, except for TJ series underwater strain gages. H–613 is especially suitable for higher accuracy and test with long term stress analysis.

## 【Characteristic】

- **Operation temperature range**: –30℃ ~ +150℃
- **Storage method**: shade, dry and seal storage
- **Before mixing**: 10 months storage life under the degree of 24℃
- **After mixing**: within 20 minutes use up
- **Mixing ration**: part A: part B=10:3
- **Curing method**: press and rom temperature curing
- **Inflate**: 0.03–0.05MPa
- **Curing temperature**: curing 24 hours underthedegree of 24℃ (after 3~4 days reached the best intensity); or curing 3 hours under the degree of 80℃ .

## 【Packing Specification】

6 bottles/ box: 3 bottles of A part(10g/ bottle);

3 bottles of B part (3g/ bottle);

2 bottles/ box: 1 bottle of A part(10g/ bottle);

1 bottle of B part (3g/ bottle)

